



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

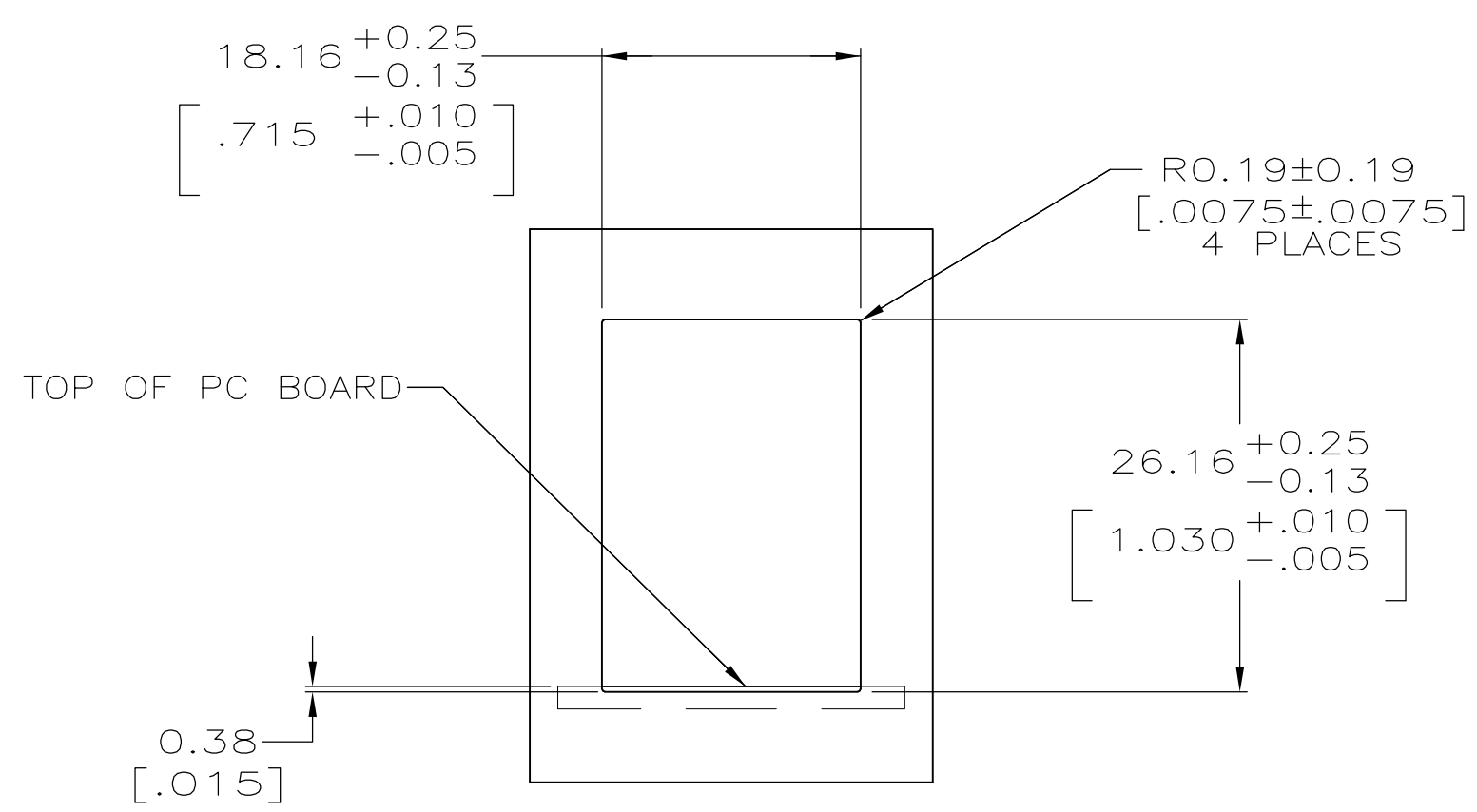
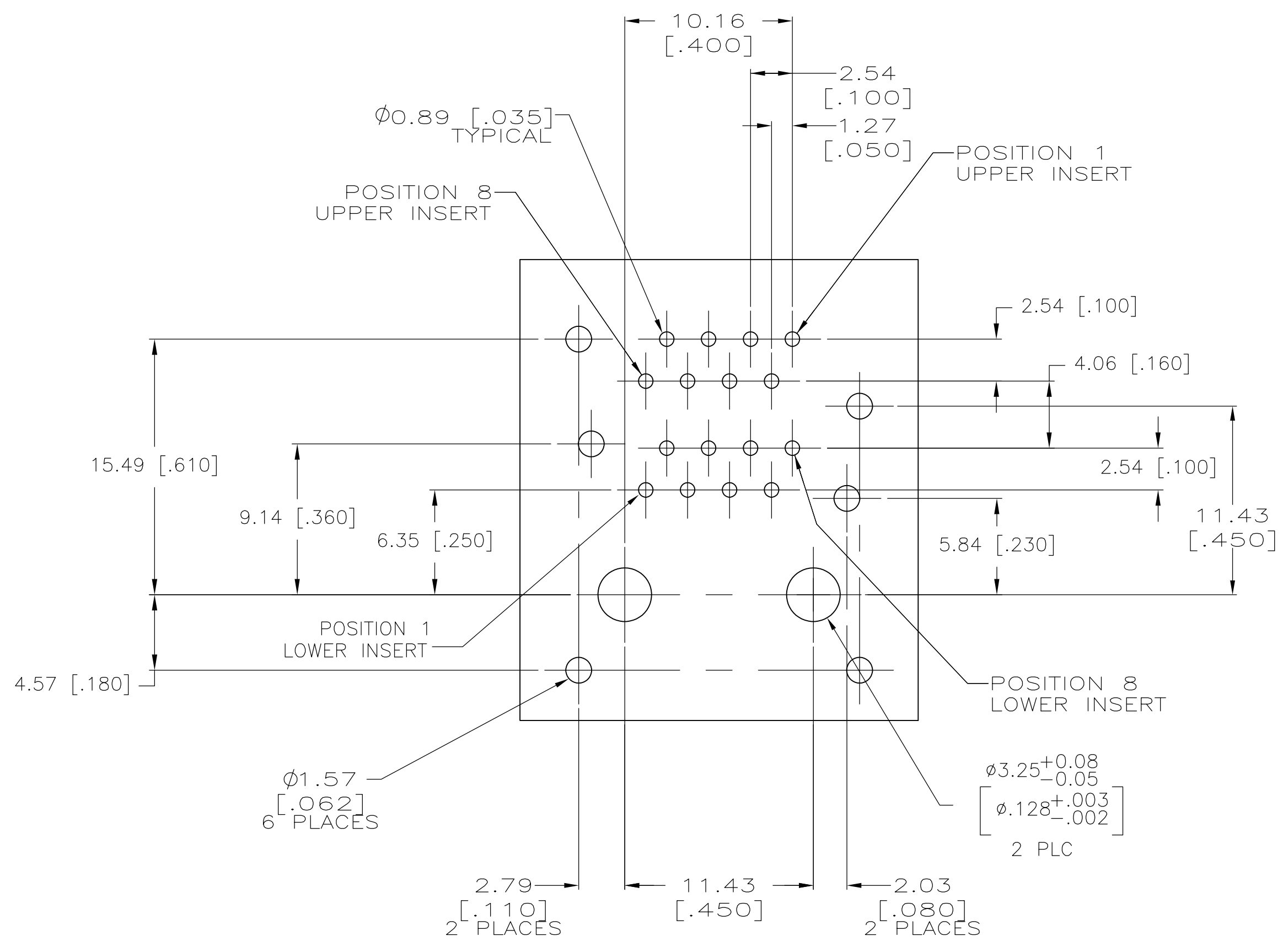
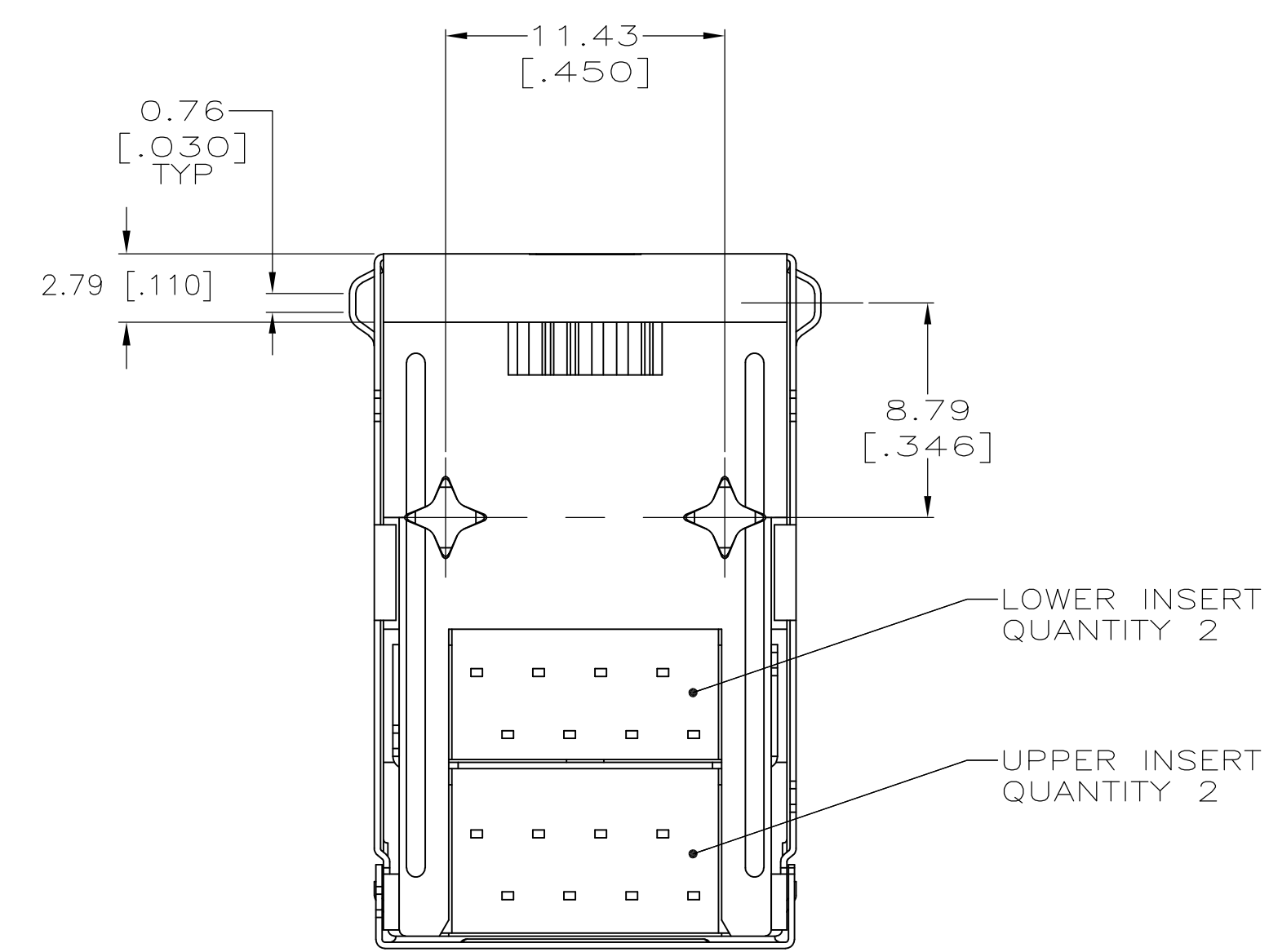
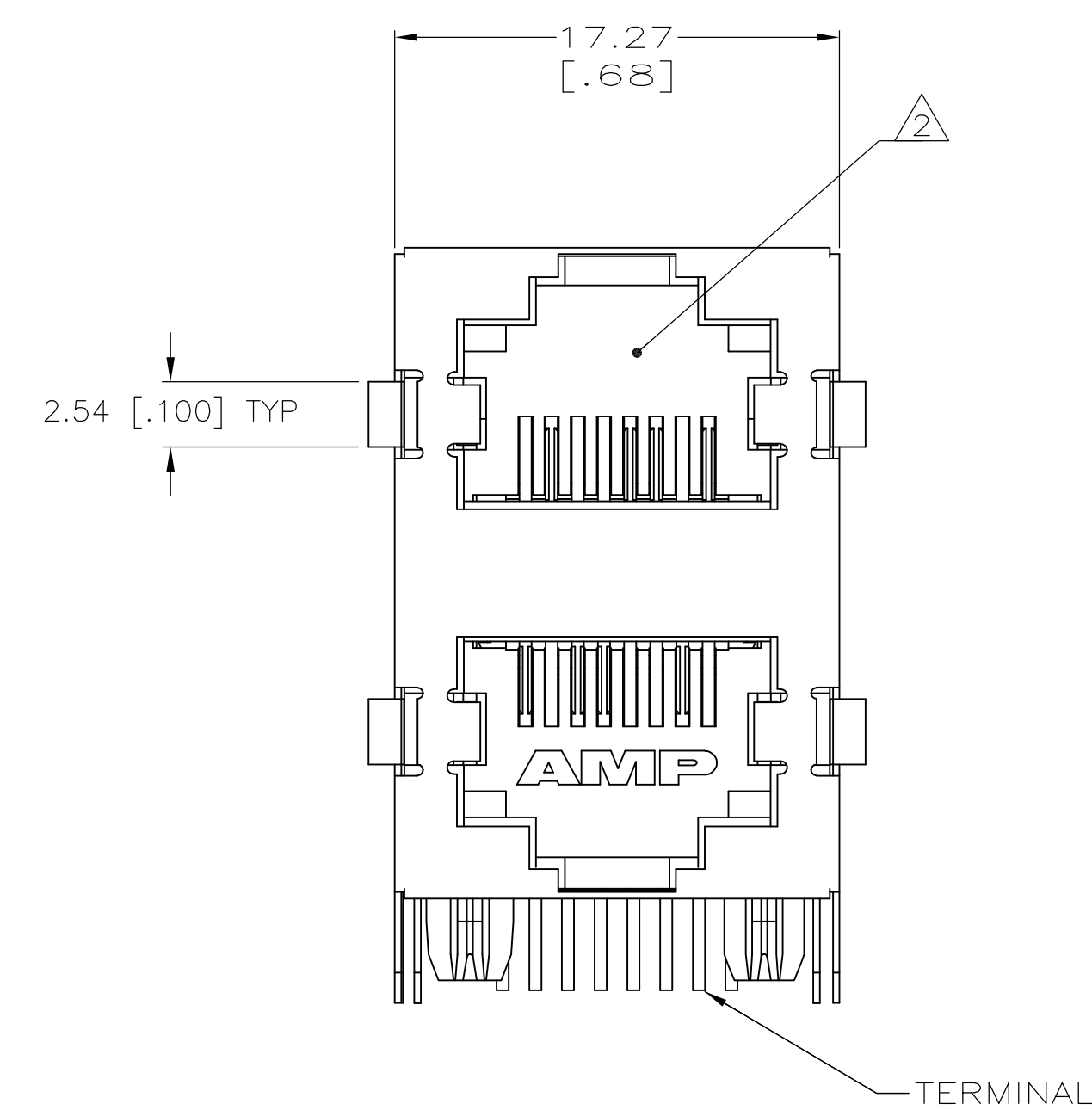
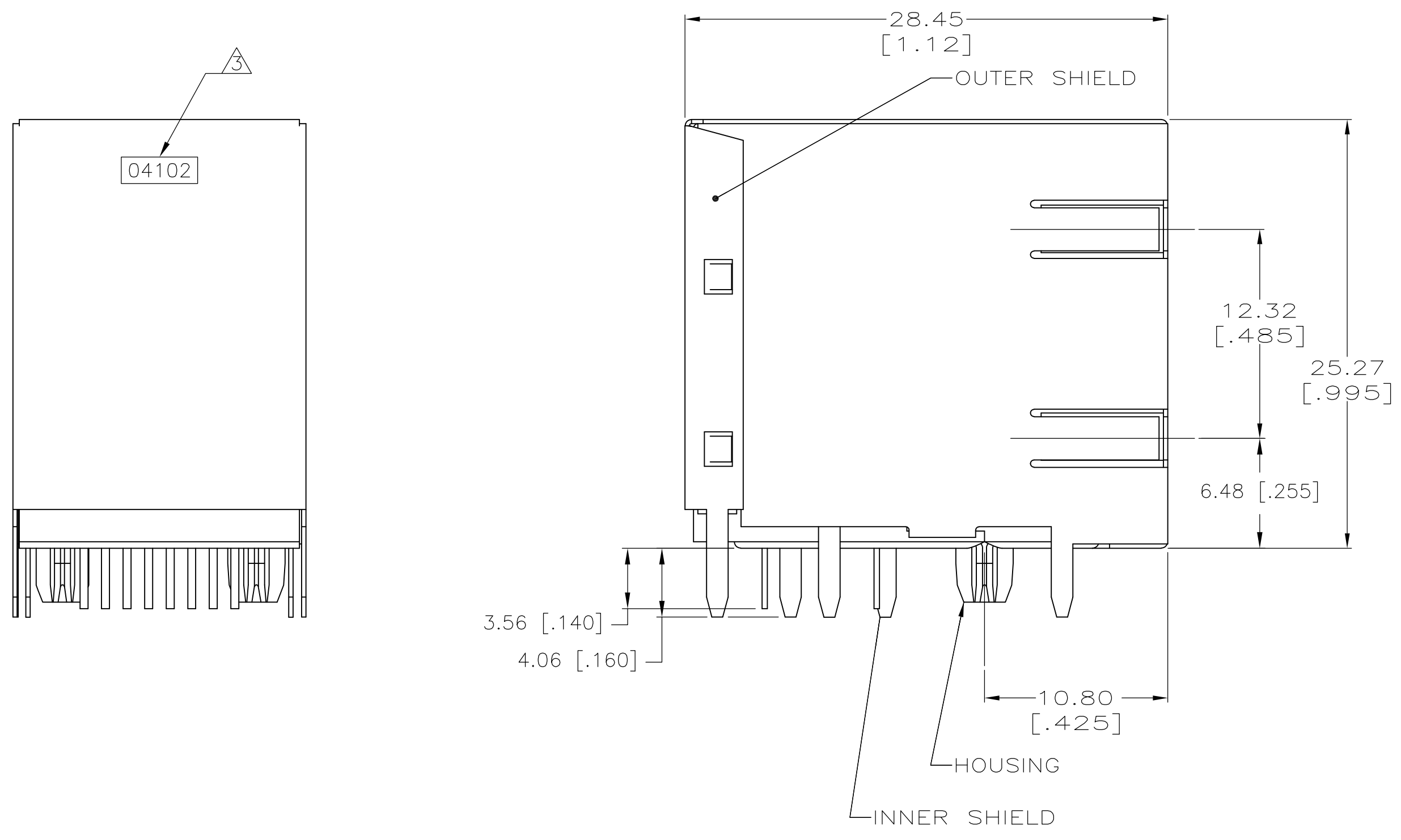
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LOC	DIST	REVISIONS			
P	LTR	DESCRIPTION	DATE	DWN	APVD
B1	REV PER	ECR-08-009376	6MAY2008	DZ	SY



SUGGESTED PANEL CUTOUT DIMENSIONS
 SCALE 2:1

PC BOARD LAYOUT VIEWED FROM COMPONENT SIDE

- MATERIAL:
 HOUSING - PCT POLYESTER, BLACK, UL94V-0.
 OVERMOLDED TERMINAL ARRAY - HIGH TEMPERATURE NYLON, COLOR: NATURAL
 TERMINALS - 0.33 [.013] THICK PHOS BRONZE PLATED WITH 1.27um [.000050] MIN THICK HARD GOLD IN LOCALIZED AREA AND 3.81um [.000150] MIN THICK MATTE TIN IN SOLDER AREA OVER 1.27um [.000050] MIN THICK NICKEL UNDERPLATE.
 INNER SHIELD - 0.25 [.010] THICK COPPER ALLOY PLATED WITH 2.03um [.000080] MIN BRIGHT TIN OVER 1.27um [.000050] MIN NICKEL.
 OUTER SHELL - 0.25 [.010] THICK COPPER ALLOY PLATED WITH 1.27um [.000050] MIN NICKEL. PCB GROUND TABS DIPPED WITH 2.03um [.00080] MIN TIN
- JACK CAVITY CONFORMS TO FCC RULES AND REGULATIONS, PART 68 SUBPART F.
- DATE CODE LOCATED ON REAR OF PART APPROXIMATELY AS SHOWN:
 FIRST 2 DIGITS ARE LAST 2 DIGITS OF YEAR, SECOND 2 DIGITS ARE MANUFACTURING WORK WEEK, LAST DIGIT IS DAY OF WEEK, WITH SUNDAY = 1.
- PARTS PACKAGED IN SEALED BAGS WITH DESICCANT
- PARTS SUITABLE FOR LEAD FREE REFLOW PROCESSING TO 260° C
- THIS PRODUCT HAS NOT COMPLETED VALIDATION TESTION, SO THE STATUS IS PRELIMINARY.

2007022-1
 PART NUMBER

THIS DRAWING IS A CONTROLLED DOCUMENT.		DWN T. SPRINKLE / A. MAYER 21MAY2005	21MAY2005	Tyco Electronics Corporation Harrisburg, Pa 17105-3608	
DIMENSIONS: mm [INCHES]		CHK J. WESTMAN 21MAY2005	21MAY2005	NAME STACKED MODULAR JACK ASSEMBLY, 2x1 PORT, 8 POSITION, SHIELDED, PANEL GROUND, CATEGORY 5, GIGABIT ETHERNET	
TOLERANCES UNLESS OTHERWISE SPECIFIED:		APVD S. SLICKINGER 21MAY2005	21MAY2005	PRODUCT SPEC 108-1163-2	
0 PLC	±			APPLICATION SPEC 114-2048	
1 PLC	±			SIZE A1	
2 PLC	± 0.25[.01]			CAGE CODE 00779	
3 PLC	± 0.13[.005]			DRAWING NO 2007022	
4 PLC	±			RESTRICTED TO	
ANGLES	±			WEIGHT	
MATERIAL SEE NOTE 1		FINISH SEE NOTE 1		CUSTOMER DRAWING	
		SCALE 4:1		SHEET 1 OF 1	
				REV B1	